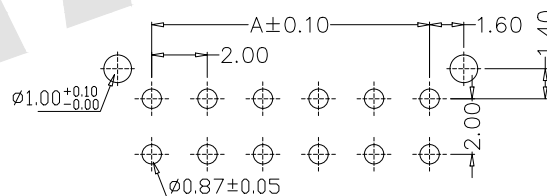
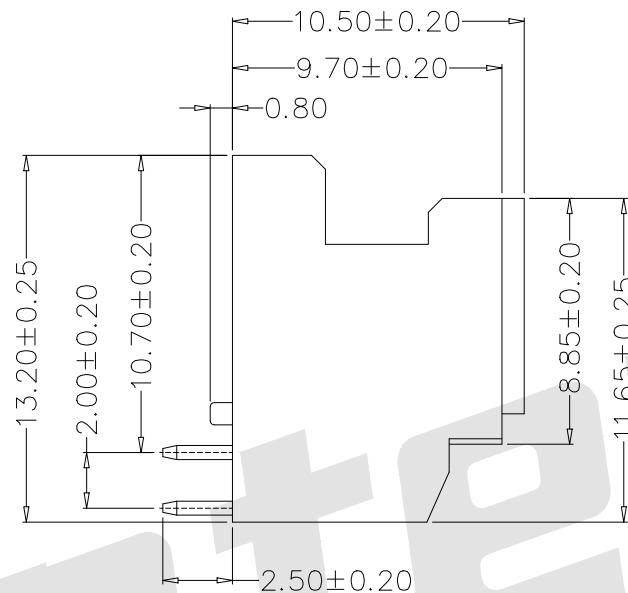
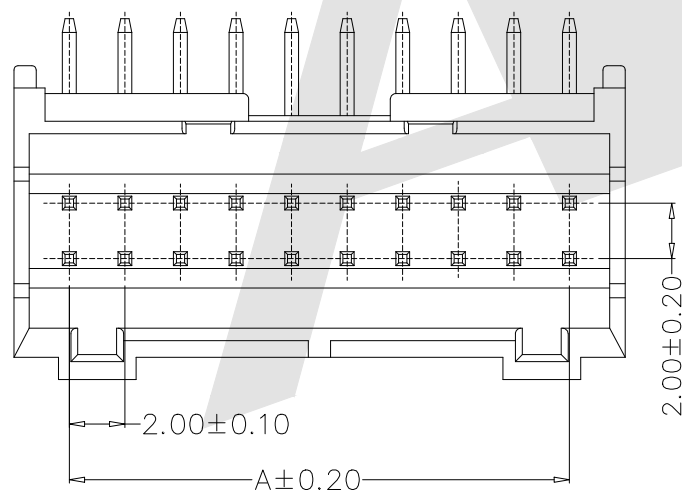
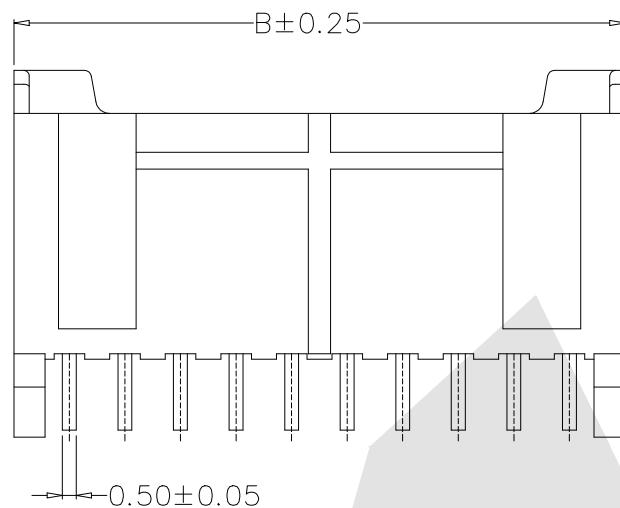


HSF



RoHS



PCB LAYOUT

SPECIFICATIONS

1. Current Rating: 3A AC, DC
2. Voltage Rating: 250V AC, DC
3. Temperature Range: - 25°C~+85°C
4. Contact Resistance: 20m Ω Max
5. Insulation Resistance: 1000M Ω Min
6. Withstanding Voltage: 800V AC/minute
7. Material: Nylon66+ Fiber 25%,UL94V-0

Ordering Code:

AW2019R - 2xN - X - 01
① ② ③ ④

① Series No.

② Pins No.
See Table

③ Contact Plating

G0: Gold Flash S0: Gold Flash/Sn
G1: 3u" Gold S1: 3u" Gold/Sn
G2: 5u" Gold S2: 5u" Gold/Sn
G3: 10u" Gold S3: 10u" Gold/Sn
G4: 15u" Gold S4: 15u" Gold/Sn
G5: 30u" Gold S5: 30u" Gold/Sn

④ Serial No.

Pins	Dimension	
	A	B
2x02	2.00	6.00
2x03	4.00	8.00
2x04	6.00	10.00
2x05	8.00	12.00
2x06	10.00	14.00
2x07	12.00	16.00
2x08	14.00	18.00
2x09	16.00	20.00
2x10	18.00	22.00
2x11	20.00	24.00
2x12	22.00	26.00
2x20	38.00	42.00

Unless Otherwise specified tolerance
X.±0.35 X.XX:±0.20
X.X:±0.25 X.XXX:±0.15

SCALE: As Shown UNIT: mm
DRAW ZLA DATE 08/07/2023
CHECK BobYang DATE 08/07/2023

VER./版本号



3rd ANGLE PROJECTION

Antenk ANTENK ELECTRONICS CO.,LTD
Http://www.antenk.com
E-mail:sales@antenk.com

TITLE: 2.0 Pitch SPH Series Dual Row 90° Wafer
Connector

DRAWING NO: AW2019R-2xN-X-01

PRODUCT NO: AW2019R-2xN-X-01

MK/标记

DESCRIPTION/修订内容

DATE/日期(M/D/Y)